

Low Loss DuoPack : IGBT in TRENCHSTOP[™] and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode



Features:

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- Very low V_{CE(sat)} 1.5V (typ.)
- Maximum Junction Temperature 175°C
 - Short circuit withstand time 5µs
- Designed for :
 - Frequency Converters
 - Uninterrupted Power Supply
- TRENCHSTOP™ and Fieldstop technology for 600V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
 - Iow V_{CE(sat)}
- Positive temperature coefficient in V_{CE(sat)}
- Low EMI
- Low Gate Charge
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>

Туре	V _{CE}	I _C	V _{CE(sat),Tj=25℃}	T j,max	Marking	Package
IKW20N60T	600V	20A	1.5V	175°C	K20T60	PG-TO247-3

Maximum Ratings

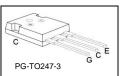
Parameter	Symbol	Value	Unit	
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V _{CE}	600	V	
DC collector current, limited by T_{jmax} $T_{C} = 25^{\circ}C$		41		
$T_{\rm C} = 100^{\circ}{\rm C}$	I _C	28		
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	60	•	
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^{\circ}C$, $t_p = 1\mu s$	-	60	A	
Diode forward current, limited by T_{jmax} $T_{C} = 25^{\circ}C$,	41		
$T_{\rm C} = 100^{\circ}{\rm C}$	/ _F	28		
Diode pulsed current, t_p limited by T_{jmax}	I _{Fpuls}	60		
Gate-emitter voltage	V _{GE}	±20	V	
Short circuit withstand time ²⁾	4	5		
V_{GE} = 15V, $V_{\text{CC}} \le 400$ V, $T_j \le 150^{\circ}$ C	t _{sc}	5	μs	
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P _{tot}	166	W	
Operating junction temperature	Tj	-40+175		
Storage temperature	T _{stg}	-55+150	°C	
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260		

¹ J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.

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Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				1
IGBT thermal resistance,	P		0.0	
junction – case	R _{thJC}		0.9	
Diode thermal resistance,	D		4.5	K/W
junction – case	R_{thJCD}		1.5	
Thermal resistance,	D		40	
junction – ambient	R _{thJA}		40	

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Devementer	Cumb ol	Conditions	Value			11
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_{C}=0.2mA$	600	-	-	
Collector-emitter saturation voltage		$V_{\rm GE} = 15 V, I_{\rm C} = 20 A$				
	V _{CE(sat)}	<i>T</i> _j =25°C	-	1.5	2.05	
		<i>T</i> _j =175°C	-	1.9	-	V
Diode forward voltage		$V_{\rm GE} = 0V, I_{\rm F} = 20A$				- V
	V _F	<i>T</i> _j =25°C	-	1.65	2.05	
		<i>T</i> _j =175°C	-	1.6	-	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 290 \mu {\rm A}, V_{\rm CE} = V_{\rm GE}$	4.1	4.9	5.7	
Zero gate voltage collector current		V _{CE} =600V, V _{GE} =0V				
	I _{CES}	<i>T</i> _j =25°C	-	-	40	μA
		<i>T</i> _j =175°C	-	-	1500	
Gate-emitter leakage current	I _{GES}	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA
Transconductance	$g_{ m fs}$	$V_{\rm CE} = 20 V, I_{\rm C} = 20 A$	-	11	-	S
Integrated gate resistor	R _{Gint}			-		Ω

Dynamic Characteristic

-						
Input capacitance	Ciss	$V_{CE}=25V$,	-	1100	-	
Output capacitance	Coss	$V_{GE}=0V$,	-	71	-	pF
Reverse transfer capacitance	Crss	f=1MHz	-	32	-	
Gate charge	Q _{Gate}	V _{CC} =480V, <i>I</i> _C =20A V _{GE} =15V	-	120	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L _E	PG-TO247-3	-	13	-	nH
Short circuit collector current ¹⁾	I _{C(SC)}	V_{GE} =15V, t_{SC} ≤5µs V_{CC} = 400V, T_j ≤ 150°C	-	183.3	-	А

 $^{1)}$ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at $T_j=25 \text{ °C}$

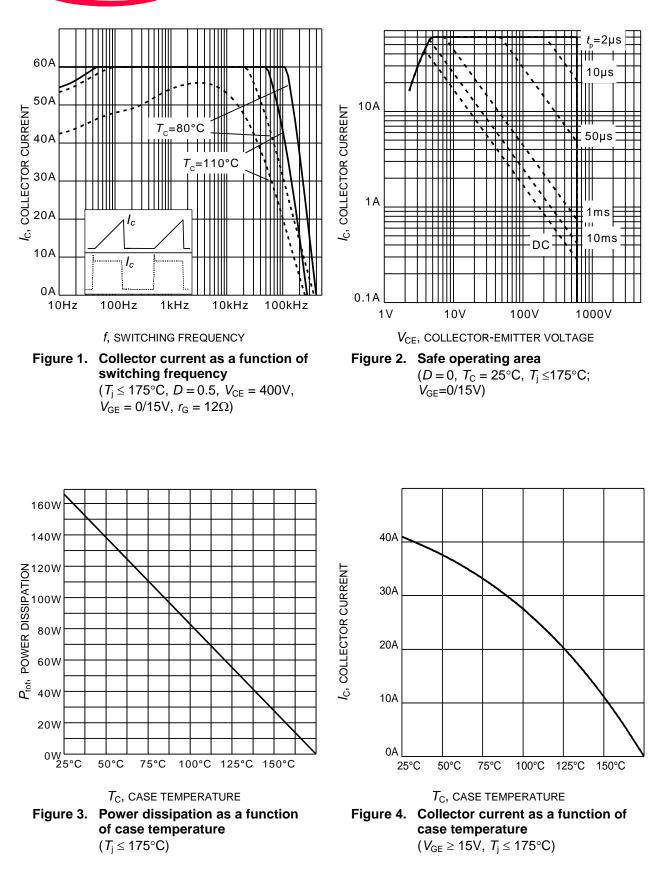
Poromotor	Symbol	Conditions	Value			l Imit
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =25°C,	-	18	-	- ns
Rise time	t _r	$V_{\rm CC} = 400 \text{V}, I_{\rm C} = 20 \text{A},$ $V_{\rm GE} = 0/15 \text{V}, r_{\rm G} = 12 \Omega,$	-	14	-	
Turn-off delay time	$t_{d(off)}$	$L_{\sigma} = 131 \text{ nH}, C_{\sigma} = 31 \text{ pF}$	-	199	-	
Fall time	t _f]	-	42	-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.31	-	mJ
Turn-off energy	E _{off}		-	0.46	-	
Total switching energy	Ets		-	0.77	-	
Anti-Parallel Diode Characteristic		·				
Diode reverse recovery time	t _{rr}	<i>T</i> _j =25°C,	-	41	-	ns
Diode reverse recovery charge	Q _{rr}	V _R =400V, <i>I</i> _F =20A,	-	0.31	-	μC
Diode peak reverse recovery current	<i>I</i> _{rrm}	di _F /dt=880A/µs	-	13.3	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	711	-	A/µs

Switching Characteristic, Inductive Load, at T_j=175 °C

Deveryor	Cumbal	O an alltion a	Value			11
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =175°C,	-	18	-	- ns
Rise time	t _r	$V_{\rm CC} = 400 \text{V}, I_{\rm C} = 20 \text{A},$ $V_{\rm GE} = 0/15 \text{V}, r_{\rm G} = 12 \Omega,$	-	18	-	
Turn-off delay time	t _{d(off)}	L_{σ} =131nH, C_{σ} =31pF	-	223	-	
Fall time	<i>t</i> _f		-	76	-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.51	-	mJ
Turn-off energy	E _{off}		-	0.64	-	
Total switching energy	Ets		-	1.15	-	
Anti-Parallel Diode Characteristic						
Diode reverse recovery time	t _{rr}	<i>T</i> _j =175°C	-	176	-	ns
Diode reverse recovery charge	Q _{rr}	$V_{\rm R}$ =400V, $I_{\rm F}$ =20A,	-	1.46	-	μC
Diode peak reverse recovery current	l _{rrm}	di _F /dt=880A/µs	-	18.9	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	467	-	A/μs

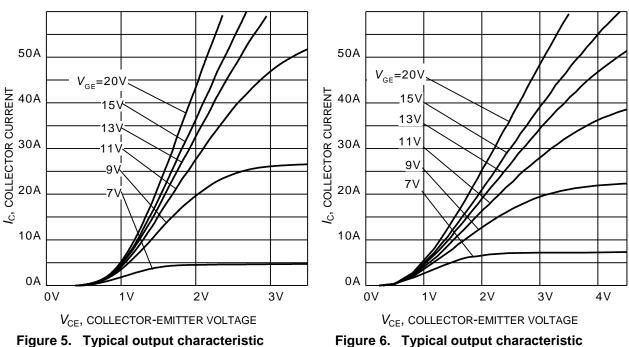


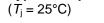
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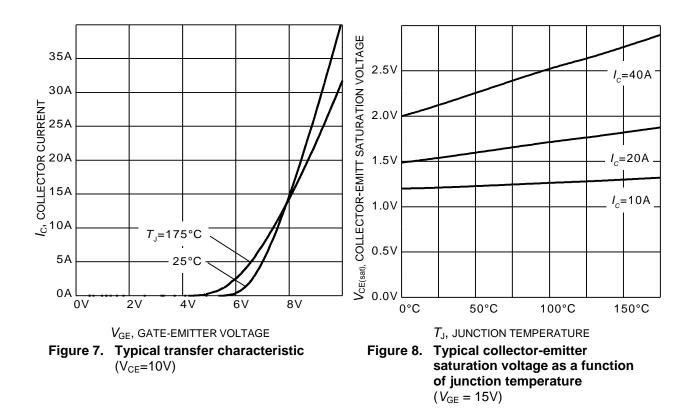
TRENCHSTOP[™] Series





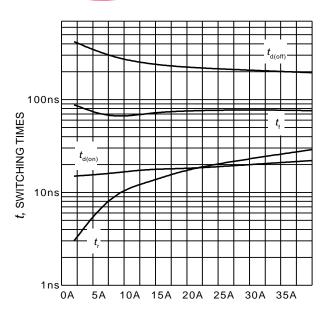


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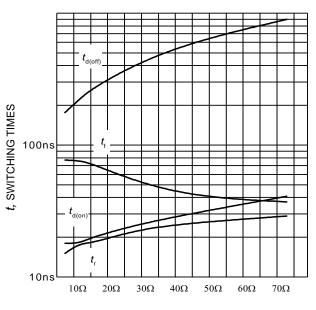


TRENCHSTOP™ Series



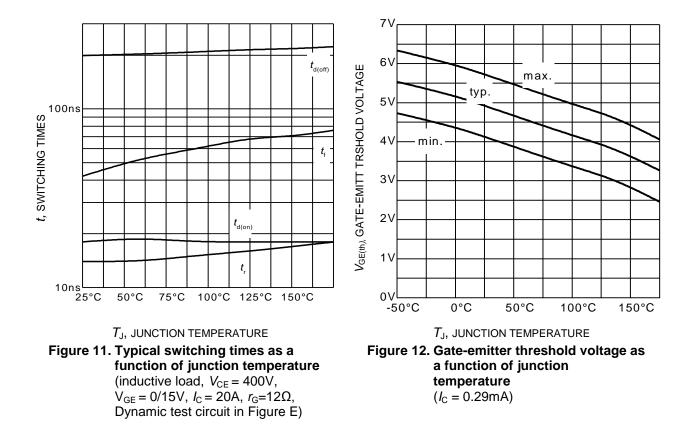
 I_C , COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current (inductive load, $T_J=175^{\circ}C$, $V_{CE} = 400V$, $V_{GE} = 0/15V$, $r_G = 12\Omega$, Dynamic test circuit in Figure E)



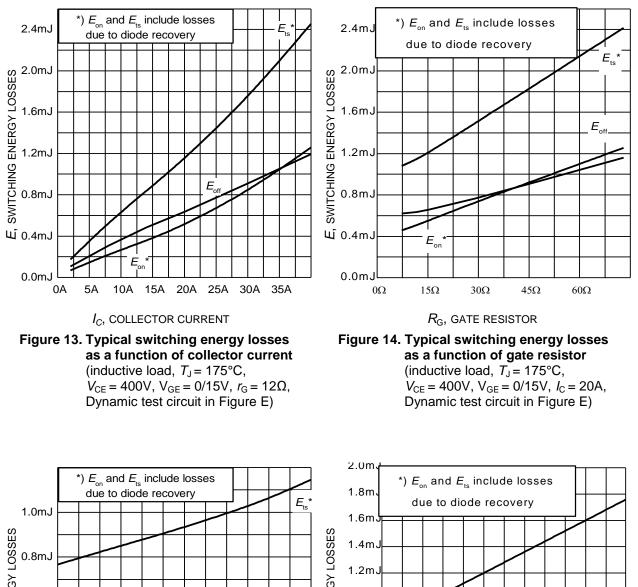
 $R_{\rm G}$, gate resistor

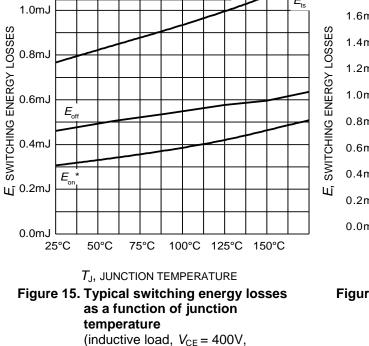
Figure 10. Typical switching times as a function of gate resistor (inductive load, $T_J = 175^{\circ}$ C, $V_{CE} = 400$ V, $V_{GE} = 0/15$ V, $I_C = 20$ A, Dynamic test circuit in Figure E)





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 $V_{GE} = 0/15V, I_C = 20A, r_G = 12\Omega,$

Dynamic test circuit in Figure E)

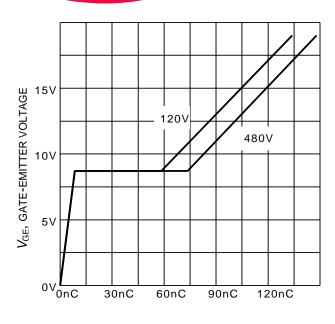
1.0mJ E_{ts}^{*} 0.8mJ E_{off}^{*} 0.6mJ E_{on}^{*} 0.2mJ 0.0mJ E_{on}^{*} 0.0mJ 0.0mJ

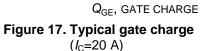
 V_{CE} , COLLECTOR-EMITTER VOLTAGE Figure 16. Typical switching energy losses as a function of collector emitter voltage (inductive load, T_{J} = 175°C,

 $V_{GE} = 0/15V$, $I_C = 20A$, $r_G = 12\Omega$, Dynamic test circuit in Figure E)



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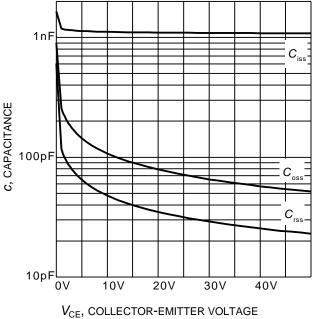
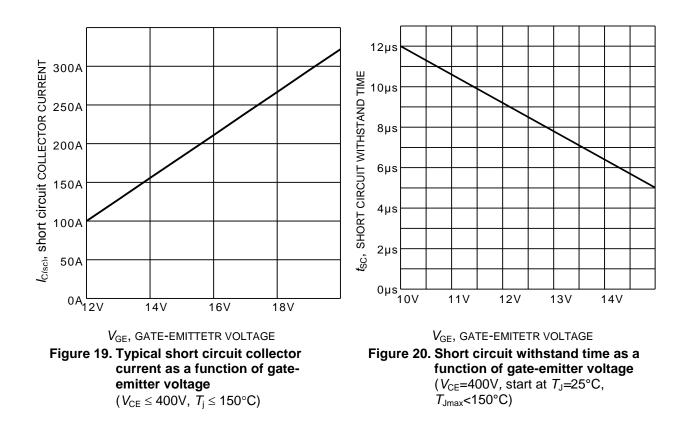


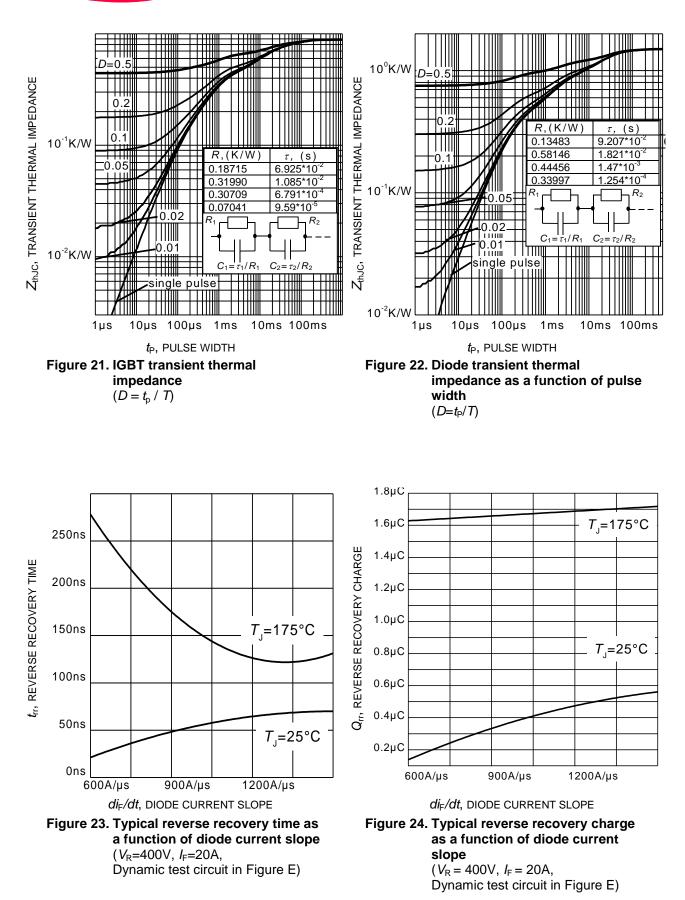
Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f = 1 \text{ MHz})$





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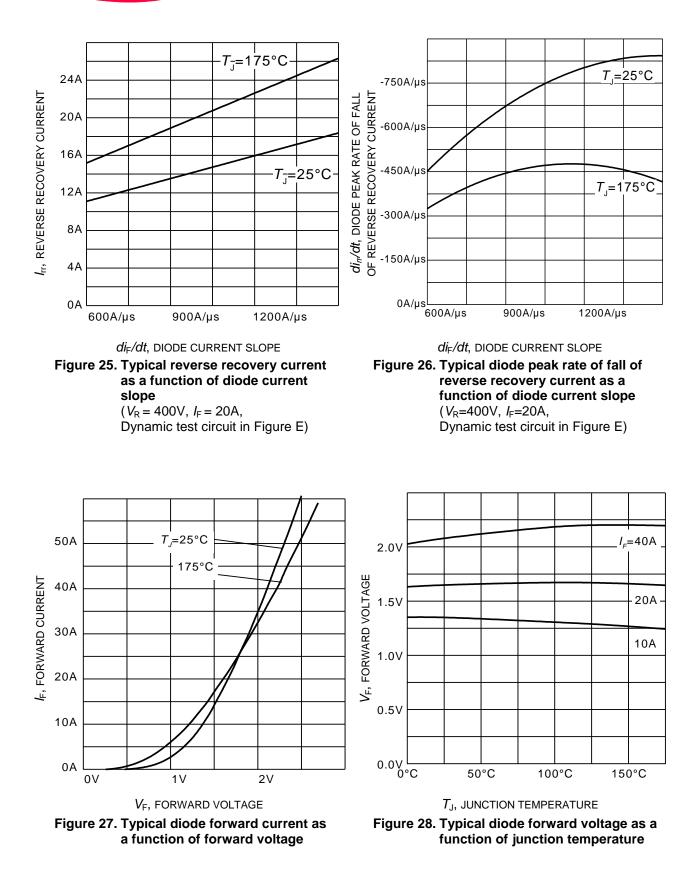
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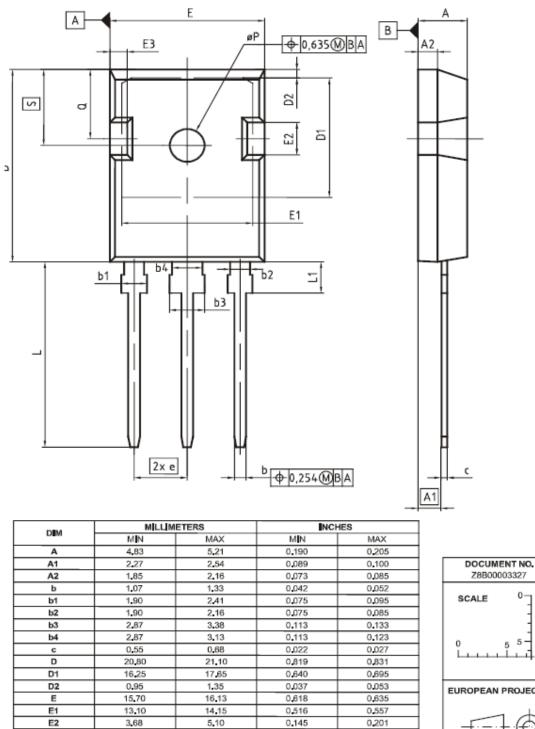
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TRENCHSTOP[™] Series

PG-TO247-3



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1.00

19,80

4.10

3,50

5,49

6.04

0.039

0.780

0,161

0.138

0,216

0,238

2,60

20.32

4.47

3,70

6,00

6,30

5.44 (BSC)

3

0.102

0,800

0.176

0.146

0,236

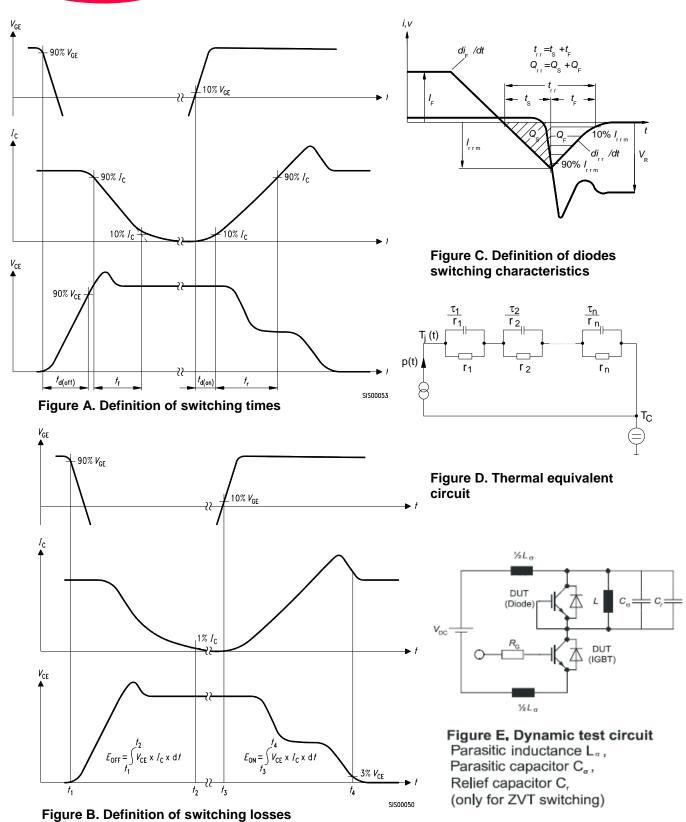
0,248

0.214 (BSC)

3



TRENCHSTOP[™] Series



IFAG IPC TD VLS



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